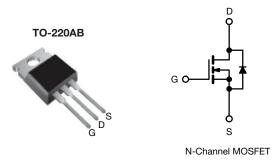
SiHP17N80AE

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY		
V _{DS} (V) at T _J max.	85	50
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.250
Q _g max. (nC)	6	2
Q _{gs} (nC)	8	3
Q _{gd} (nC)	1	8
Configuration	Sin	gle

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (C_{o(er)})
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP17N80AE-GE3

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, un	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	800	v
Gate-source voltage			V _{GS}	± 30	v
Continuous drain current (T ₁ = 150 °C)	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	1	15	
Continuous drain current $(1) = 150^{\circ}$ C)	VGS at 10 V	T _C = 100 °C	۱ _D	10	А
Pulsed drain current ^a			I _{DM}	32	
Linear derating factor				1.4	W/°C
Single pulse avalanche energy ^b			E _{AS}	127	mJ
Maximum power dissipation			PD	179	W
Operating junction and storage temperature range	ge		T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope		T _J = 125 °C	du /dt	100	1//22
Reverse diode dv/dt ^d			dv/dt	17	V/ns
Soldering recommendations (peak temperature)	с	For 10 s		260	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 $\Omega,$ I_{AS} = 3 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, di/dt = 100 A/µs, starting T_J = 25 °C

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PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum junction-to-ambient	R _{thJA}	-		62 0.7			°0.00	
Maximum junction-to-case (drain)	R _{thJC}	-				°C/W		
			·					
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$,	unless otherw	ise noted)						
PARAMETER	SYMBOL		T CONDIT	ONS	MIN.	TYP.	MAX.	UNI
Static		1			•	•	1	
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	50 µA	800	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I _D = 1 mA	-	0.8	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 μA	2	-	4	V
Octo come laska a			$V_{GS} = \pm 20$	V	-	-	± 100	nA
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 30$	V	-	-	± 1	μA
Zara anto voltare durin comment		V _{DS} =	= 800 V, V _{GS}	s = 0 V	-	-	1	
Zero gate voltage drain current	IDSS	V _{DS} = 640 V	/, V _{GS} = 0 V	, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D	= 8.5 A	-	0.250	0.290	Ω
Forward transconductance a	9 _{fs}	V _{DS}	= 10 V, I _D =	8.5 A	-	7.1	-	S
Dynamic					•	•		
Input capacitance	C _{iss}		$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	1260	-	
Output capacitance	C _{oss}				-	56	-	
Reverse transfer capacitance	C _{rss}				-	5	-	
Effective output capacitance, energy related	C _{o(er)}	V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	40	-	pF	
Effective output capacitance, time related	C _{o(tr)}	$V_{\rm DS} = 0$	v to 480 v,	$v_{GS} = 0 v$	-	245	-	
Total gate charge	Qg				-	41	62	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	I _D = 8.5 /	A, V _{DS} = 640 V	-	8	-	nC
Gate-drain charge	Q _{gd}				-	18	-	
Turn-on delay time	t _{d(on)}		•		-	21	42	
Rise time	t _r	V _{DD} =	= 640 V, I _D =	8.5 A,	-	23	46	1
Turn-off delay time	t _{d(off)}	V _{GS} =	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	45	90	- ns
Fall time	t _f				-	31	62	
Gate input resistance	Rg	f = 1	MHz, open	drain	0.2	0.5	1.1	Ω
Drain-Source Body Diode Characteris		•						
Continuous source-drain diode current	IS	MOSFET symbol showing the		-	-	15		
Pulsed diode forward current	I _{SM}	p - n junction			-	-	32	A
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 8.5 A	, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}			-	314	628	ns	
Reverse recovery charge	Q _{rr}		5 °C, I _F = I _S 100 Α/μs, V		-	4	8	μC
Reverse recovery current	I _{RRM}		100 Avµs, v	K - 20 V	_	21	-	A

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

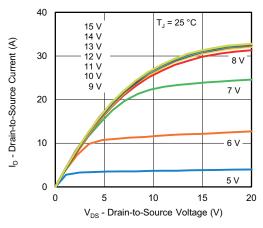


Fig. 1 - Typical Output Characteristics

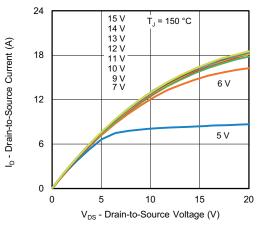


Fig. 2 - Typical Output Characteristics

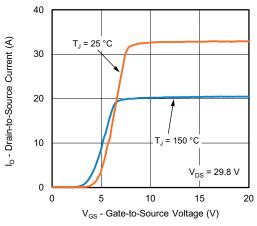


Fig. 3 - Typical Transfer Characteristics

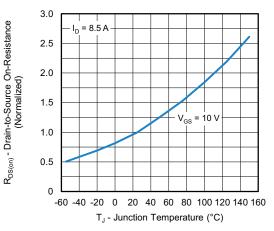


Fig. 4 - Normalized On-Resistance vs. Temperature

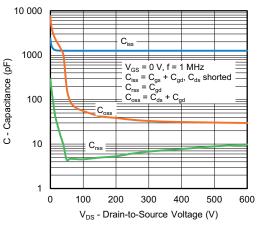
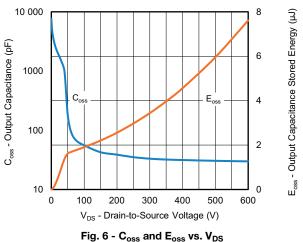


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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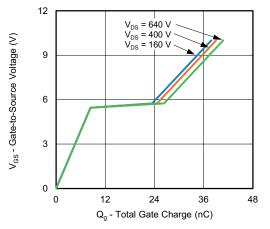


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

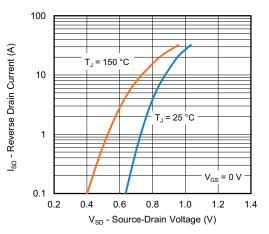


Fig. 8 - Typical Source-Drain Diode Forward Voltage

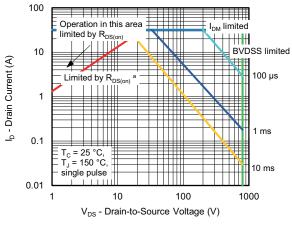


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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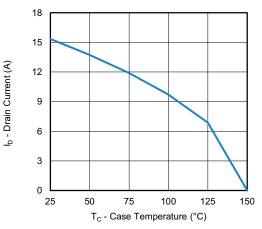


Fig. 10 - Maximum Drain Current vs. Case Temperature

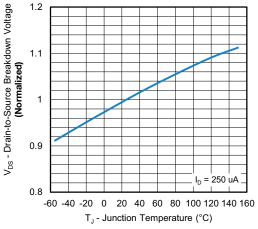
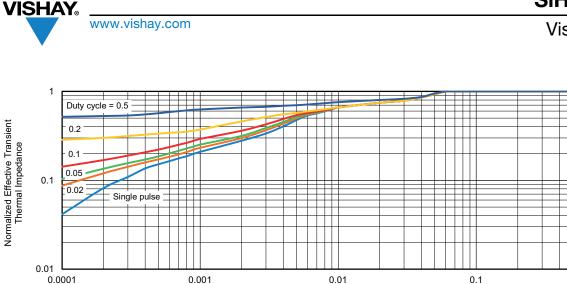
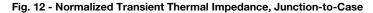


Fig. 11 - Temperature vs. Drain-to-Source Voltage



Pulse Time (s)



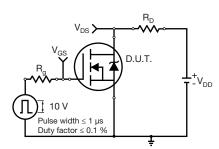


Fig. 13 - Switching Time Test Circuit

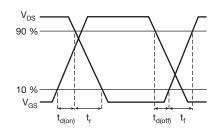


Fig. 14 - Switching Time Waveforms

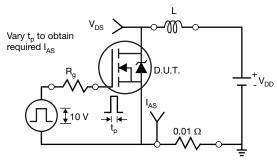


Fig. 15 - Unclamped Inductive Test Circuit

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Fig. 16 - Unclamped Inductive Waveforms

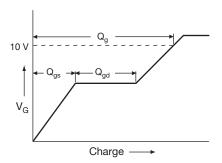


Fig. 17 - Basic Gate Charge Waveform

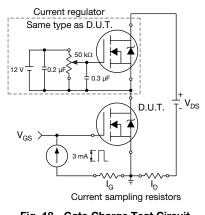


Fig. 18 - Gate Charge Test Circuit

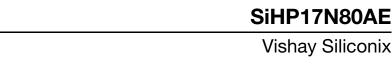
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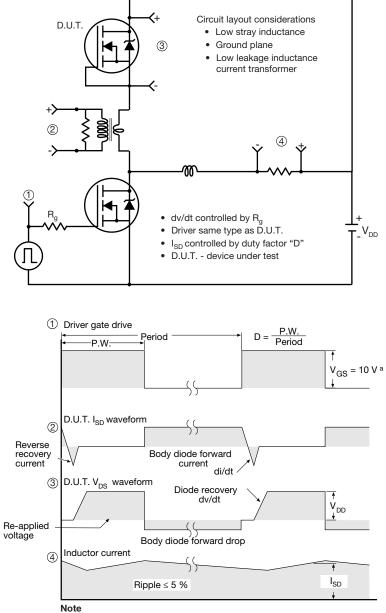
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Peak Diode Recovery dv/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig. 19 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Revison: 04-Nov-2021



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